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April 1984
Revised February 2000

DM74ALS273

Octal D-Type Edge-Triggered Flip-Flop with Clear

General Description

These monolithic, positive-edge-triggered flip-flops utilize TTL circuitry to implement D-type flip-flop logic with a direct clear input.

Information at the D inputs meeting the setup requirements is transferred to the Q outputs on the positive-going edge of the clock pulse. Clock triggering occurs at a particular voltage level and is not directly related to the transition time of the positive-going pulse. When the clock input is at either the HIGH or LOW level, the D input signal has no effect at the output.

Features

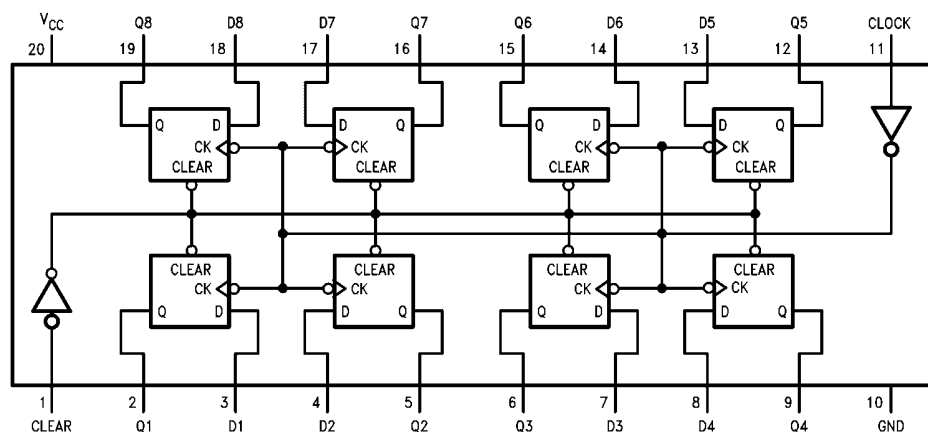
- Switching specifications at 50 pF
- Switching specifications guaranteed over full temperature and V_{CC} range
- Buffer-type outputs and improved AC offer significant advantage over DM74LS273.
- Advanced oxide-isolated, ion-implanted Schottky TTL process
- Functionally and pin-for-pin compatible with DM74LS273.

Ordering Code:

Order Number	Package Number	Package Description
DM74ALS273WM	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
DM74ALS273SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS273MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
DM74ALS273N	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram



DM74ALS273 Octal D-Type Edge-Triggered Flip-Flop with Clear

DM74ALS273

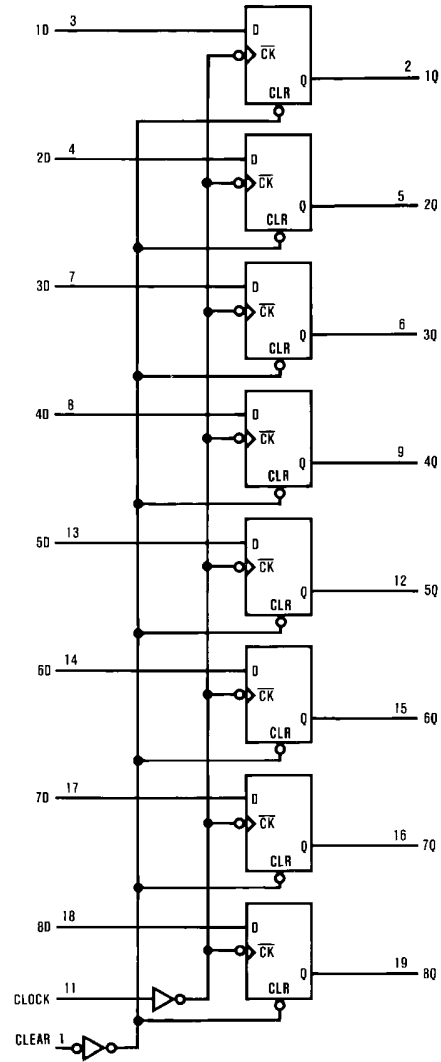
Function Table

(Each Flip-Flop)

Inputs			Output Q
Clear	Clock	D	
L	X	X	L
H	↑	H	H
H	↑	L	L
H	L	X	Q ₀

L = LOW State
H = HIGH State
X = Don't Care
↑ = Positive Edge Transition
Q₀ = Previous Condition of Q

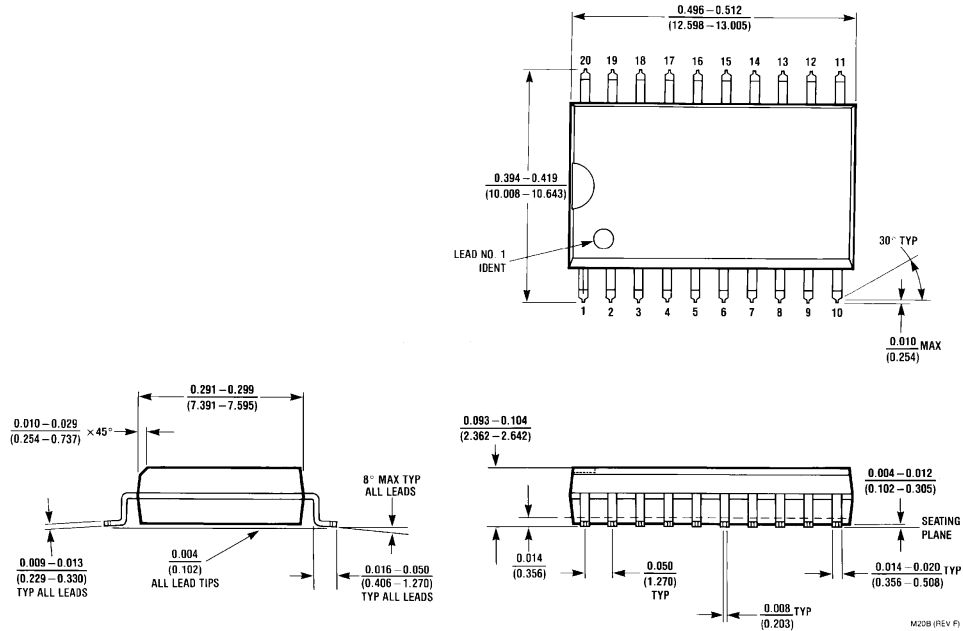
Logic Diagram



Absolute Maximum Ratings (Note 1)								
Supply Voltage						7V		
Input Voltage						7V		
Operating Free Air Temperature Range						0°C to +70°C		
Storage Temperature Range						-65°C to +150°C		
Typical θ_{JA}								
N Package						60.0°C/W		
M Package						79.0°C/W		
<p>Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.</p>								
Recommended Operating Conditions								
Symbol	Parameter		Min	Nom	Max	Units		
V_{CC}	Supply Voltage		4.5	5	5.5	V		
V_{IH}	HIGH Level Input Voltage		2			V		
V_{IL}	LOW Level Input Voltage				0.8	V		
I_{OH}	HIGH Level Output Current				-2.6	mA		
I_{OL}	LOW Level Output Current				24	mA		
f_{CLK}	Clock Frequency		0		35	MHz		
$t_{W(CLK)}$	Width of Clock Pulse	HIGH	14			ns		
		LOW	14			ns		
t_W	Width of Clear Pulse	LOW	10			ns		
t_{SU}	Data Setup Time (Note 2)		10 \uparrow			ns		
		Clear Inactive	15 \uparrow					
t_H	Data Hold Time		0 \uparrow			ns		
T_A	Free Air Operating Temperature		0		70	°C		
<p>Note 2: The (\uparrow) arrow indicates the positive edge of the Clock is used for reference.</p>								
Electrical Characteristics								
over recommended operating free air temperature range. All typical values are measured at $V_{CC} = 5V$, $T_A = 25^\circ C$.								
Symbol	Parameter	Conditions	Min	Typ	Max	Units		
V_{IK}	Input Clamp Voltage	$V_{CC} = 4.5V$, $I_I = -18 mA$			-1.5	V		
V_{OH}	HIGH Level Output Voltage	$V_{CC} = 4.5V$		2.4	3.3	V		
		$V_{CC} = 4.5V$ to $5.5V$				V		
V_{OL}	LOW Level Output Voltage	$V_{CC} = 4.5V$		0.25	0.4	V		
				0.35	0.5	V		
I_I	Input Current @ Maximum Input Voltage	$V_{CC} = 5.5V$, $V_{IH} = 7V$			0.1	mA		
I_{IH}	HIGH Level Input Current	$V_{CC} = 5.5V$, $V_{IH} = 2.7V$			20	μA		
I_{IL}	LOW Level Input Current	$V_{CC} = 5.5V$, $V_{IL} = 0.4V$			-0.2	mA		
I_O	Output Drive Current	$V_{CC} = 5.5V$, $V_O = 2.25V$	-30		-112	mA		
I_{CC}	Supply Current	$V_{CC} = 5.5V$		11	20	mA		
		Outputs OPEN	Outputs HIGH	19	29	mA		
		Outputs LOW				mA		
Switching Characteristics								
over recommended operating free air temperature range.								
Symbol	Parameter	Conditions	From	To	Min	Max	Units	
f_{MAX}	Maximum Clock Frequency	$V_{CC} = 4.5V$ to $5.5V$			35		MHz	
t_{PHL}	Propagation Delay Time	$R_L = 500\Omega$ $C_L = 50 pF$						
	HIGH-to-LOW Level Output		Clear	Any Q	4	18	ns	
t_{PLH}	Propagation Delay Time							
	LOW-to-HIGH Level Output		Clock	Any Q	2	12	ns	
t_{PHL}	Propagation Delay Time							
	HIGH-to-LOW Level Output	Clock	Any Q	3	15	ns		

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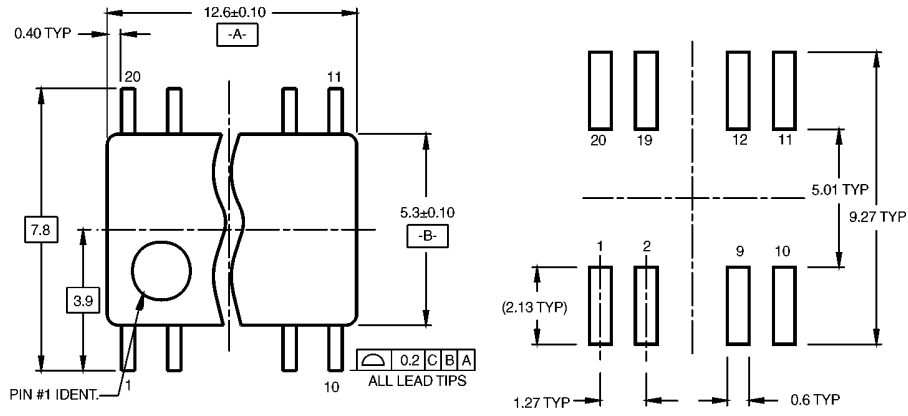
Physical Dimensions inches (millimeters) unless otherwise noted



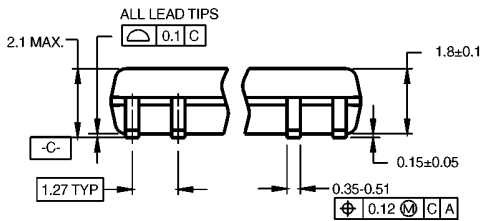
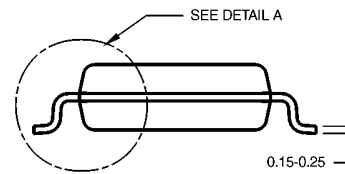
**20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M20B**

DM74ALS273

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



LAND PATTERN RECOMMENDATION

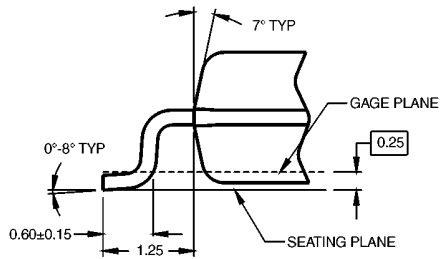


DIMENSIONS ARE IN MILLIMETERS

NOTES:

- A. CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M20DRRevB1

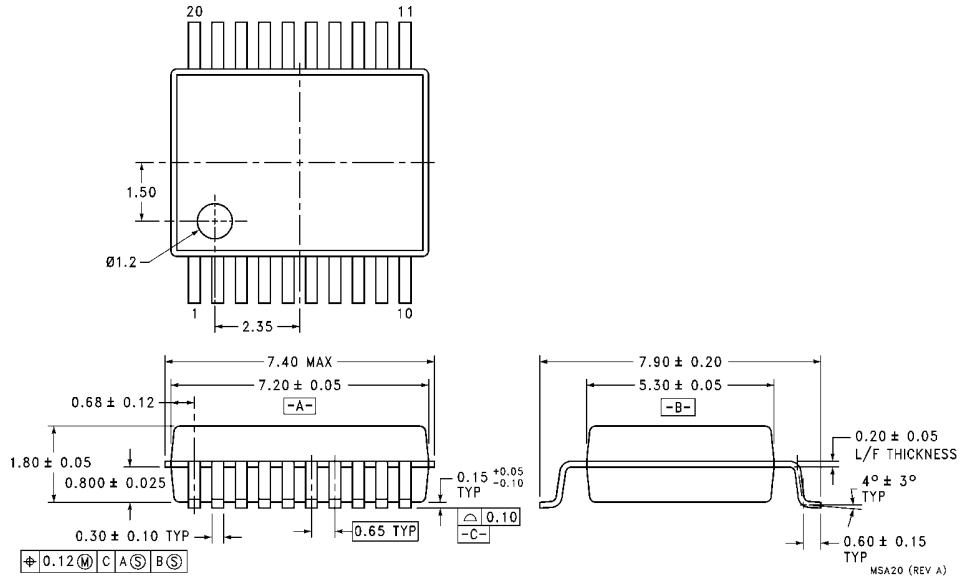


DETAIL A

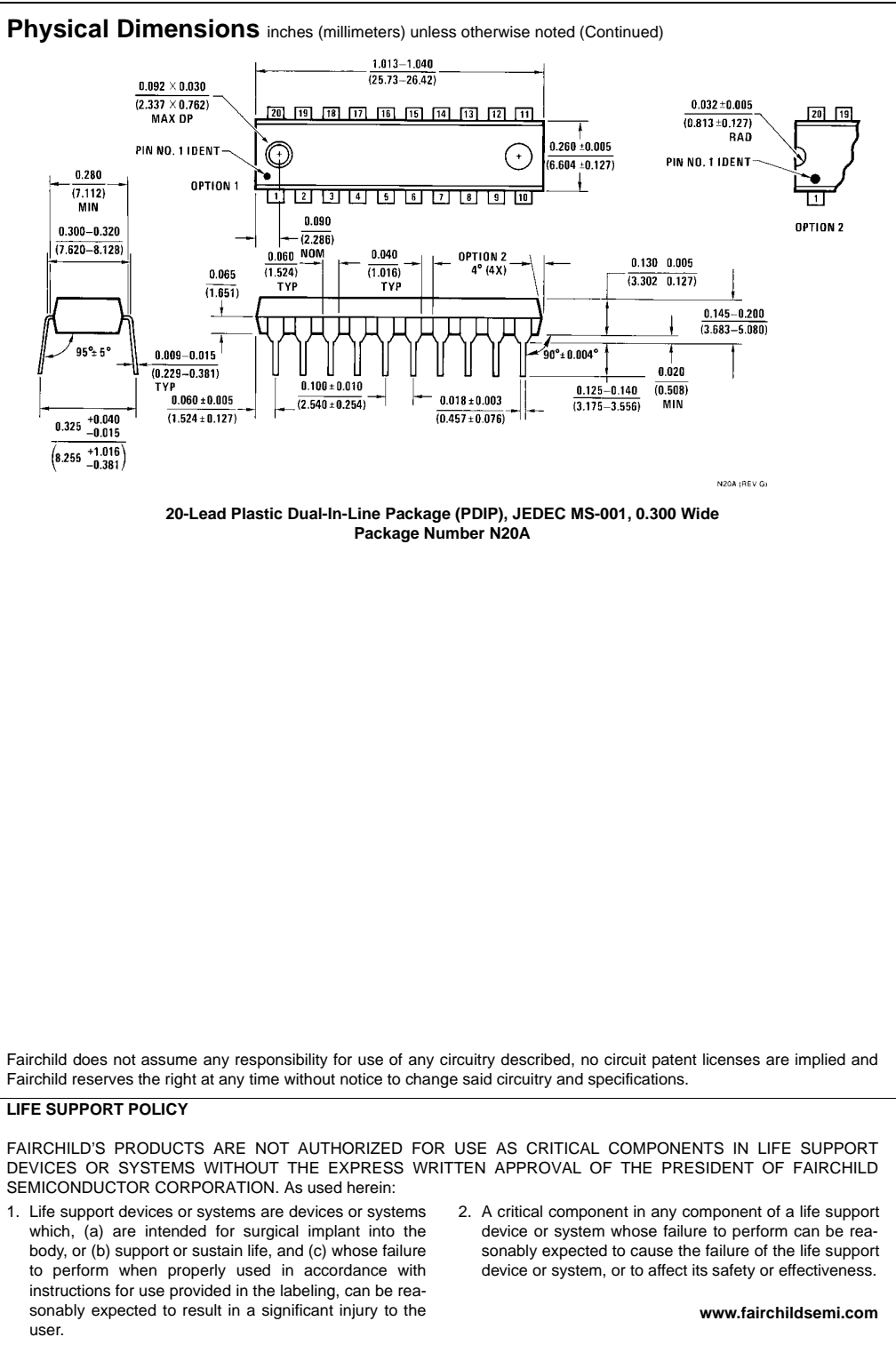
**20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M20D**

DM74ALS273

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
 Package Number MSA20**



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2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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